ASSOCIATION CONNECTING LECTRANCE INDUSTRIES® INCLUSTRIES	PC. Bannockl	burn. Illinois. A	Il rights reserved untions.	under both	This docum level parts, t	ent is a declar the declaration	ation of the encompas	substance ses all low	s within the er level ma	e manufacture terials for wh	er listed iten nich the ma	m. Note: i nufacturer	f the item is an as r has engineering	sembly with lower responsibility.
	IPC Web Site for Information on IPC-1752 Standard For http://www.ipc.org/IPC-175x Dis				 Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater 					neous Materia	als and Mfg Information			
Supplier Information														
Company name*	Company unique ID				Unique ID Authority					Response Date*				
onsemi											2025-08-17			
ontact Name Title - Contact					Phone - Contact*					Email - Contact*				
Product-Env-Stewards	Product Envi	Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com					
Authorized Representative* Title - Representati			entative P			Phone - Representative*				Email - Representative*				
Product-Env-Stewards Pro			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Iten	Number Mfr Item Name				Effective Date Version Manufacturing Si		ring Site	W	eight*	UOM	Unit Type		
	NCV302	NCV3025833MTW SPS W/THERMA SHUTDOWN		AL WARNING	AND	2025-08-17 PH1		PH1		76.555		mg	Each	
Manufacturing Proccess Informa	tion													
Terminal Plating / Grid Array Ma	inal Plating / Grid Array Material Terminal Base Alloy		Alloy	J-STD-020 MSI	L Rating	Peak Pr	A Process Body Temperature Max Time at Peak		Temperature Number of Reflow		per of Reflow Cyc	les		
Matte Tin (Sn) - annealed CU Alloy			1		260		С	30		seconds	3			
Comments														
evel 1 - maximum time at peak temperatu	ire during so	Idering is 10-3	0 seconds											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in iffies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).								
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the						
Supplier Digital Signature	astislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	19.1	mg	Supplier	Zinc (Zn)	7440-66-6		0.0229	mg
			Supplier	Iron (Fe)	7439-89-6		0.4489	mg
			Supplier	Copper (Cu)	7440-50-8		18.6225	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0057	mg
Die	2.38	mg	Supplier	Silicon (Si)	7440-21-3		2.38	mg
Die Attach Solder	1.0	mg	Supplier	Silver (Ag)	7440-22-4		0.025	mg
			А	Lead (Pb)	7439-92-1	7a	0.925	mg
			Supplier	Tin (Sn)	7440-31-5		0.05	mg
Ероху	0.75	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		0.0675	mg
			Supplier	Proprietary	Proprietary Data		0.0041	mg
			Supplier	Bismaleimide	13676-54-5		0.3784	mg
			Supplier	PTFE	9002-84-0		0.3	mg
Lead Frame	24.8	mg	Supplier	Iron (Fe)	7439-89-6		0.0248	mg
			Supplier	Copper (Cu)	7440-50-8		24.7752	mg
ead Frame plating	0.4	mg	Supplier	Silver (Ag)	7440-22-4		0.4	mg
Mold Compound-Black	26.0	mg		Epoxy resin	proprietary data		3.458	mg
			Supplier	Carbon Black (C)	1333-86-4		0.052	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		22.49	mg
lating	1.8	mg	Supplier	Tin (Sn)	7440-31-5		1.8	mg
Wire Bond	0.325	mg	Supplier	Palladium (Pd)	7440-05-3		0.0068	mg
			Supplier	Gold (Au)	7440-57-5		0.0008	mg
			Supplier	Copper (Cu)	7440-50-8		0.3174	mg